

NCE30TD65BT

Pb Free Product

650V, 30A, Trench FS II Fast IGBT

General Description

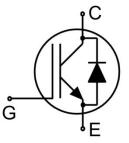
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 650V Trench FS II IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE30TD65BT	TO-247	NCE30TD65BT



TO-247

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	650	V
V _{GES}	Gate- Emitter Voltage	±30	V
	Collector Current	60	Α
Ic	Collector Current @Tc = 100°C	30	Α
I _{Cpuls}	Pulsed Collector Current, tp limited by Tjmax	120	Α
-	turn off safe operating area,V _{CE} =650V, Tj=175°C	120	Α
I _F	Diode Continuous Forward Current @T _C = 100°C	30	Α
I _{FM}	Diode Maximum Forward Current	120	Α
	Power Dissipation @ T _C = 25°C	230	W
P _D	Power Dissipation @T _C = 100 °C	115	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C
TL	Maximum Temperature for Soldering	260	°C
t _{sc}	Short circuit withstand time V_{GE} =15V, V_{CC} \leq 400V, Allowed number of short circuits<1000Time between short circuits: \geq 1.0s, T_j \leq 150°C	5	us



NCE30TD65BT

Thermal Characteristic

Symbol	Parameter	Value	Units
R _{eJC}	Thermal Resistance, Junction to case for IGBT	0.65	°C/W
R _{eJC}	Thermal Resistance, Junction to case for Diode	0.99	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

Cross la al	Davamatan	Conditions		Value			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics					'	
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	650			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V,	V _{CE} =650V			40	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} =-30	V,V _{CE} =0V			200	nA
	0 1 5 11 0 1 1 1 1	I _C =30A	Tj=25°C		1.7	1.9	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	V _{GE} =15V	Tj=175°C		1.9		uA nA nA
V _{GE(th)}	Gate Threshold Voltage	I _C =1mA	,V _{CE} =V _{GE}	4.0	5.0	6.0	V
Dynamic Cha	aracteristics			1		,	
Cies	Input Capacitance	V _{CE} =25V,V _{GE} =0V, f=1MHz			3552		pF
Coes	Output Capacitance				106		
C _{res}	Reverse Transfer Capacitance				67		
Qg	Total Gate Charge	V _{CC} =480V, I _C =30A, V _{GE} =15V			132		nC
Q _{ge}	Gate to Emitter Charge				28		
Q _{gc}	Gate to Collector Charge	V GE	-10V		54		
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V _{GE} =15V, t _{SC} ≪5us,	V _{CC} ≪400V, Tj≪150°C		180		А
Switching Cl	naracteristics						
t _{d(ON)}	Turn-on Delay Time				19		
t _r	Rise Time	V _{CC} =400V,I _C =30A,			17]
$t_{\text{d(OFF)}}$	Turn-Off Delay Time				166		ns
t _f	Fall Time	V _{GE} =0/15	$5V$, $R_g=5\Omega$,		16		
Eon	Turn-On Switching Loss	Inducti	ve Load		0.36		
E _{off}	Turn-Off Switching Loss				0.32		mJ
E _{ts}	Total Switching Loss				0.68		

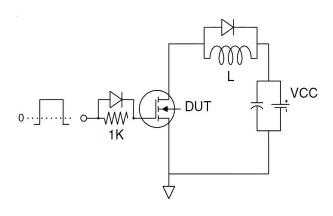
Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified)

Cumbal	Parameter	Conditions	Rating			l leite
Symbol			Min.	Тур.	Max.	Units
V_{FM}	Diode Forward Voltage	I _F =30A		1.75	2.40	V
Trr	Reverse Recovery Time	1 -20 4		178		ns
I _{RRM}	Diode Peak Reverse Recovery Current	l⊧=30A, di/dt=200A/us		4		Α
Qrr	Reverse Recovery Charge			0.4		uC
Pulse width t _{tp} ≤380μs,δ≤2%						

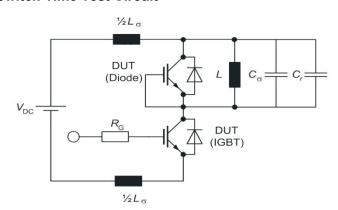


Test Circuit

1) Gate Charge Test Circuit

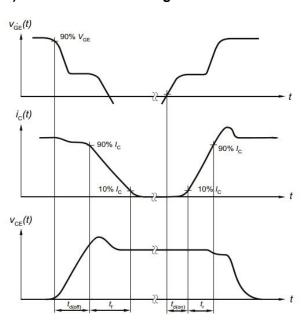


2) Switch Time Test Circuit

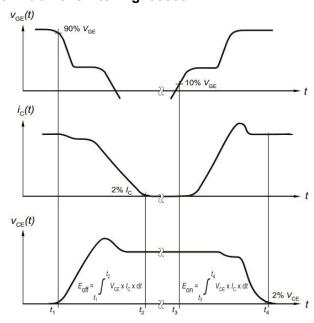


Switching characteristics

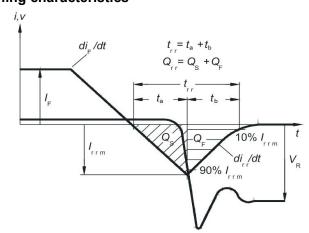
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics





Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

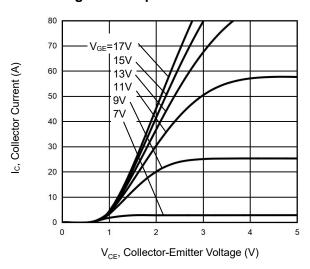


Figure 3 V_{CEsat} vs. Case Temperature

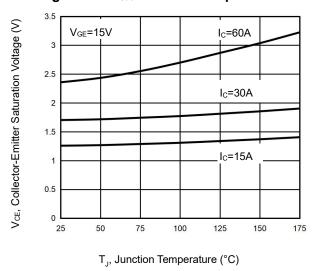


Figure 5 Capacitance Characteristics

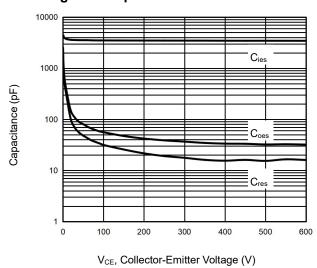


Figure 2 Transfer Characteristics

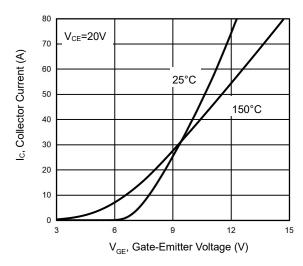


Figure 4 Saturation Voltage vs. V_{GE}

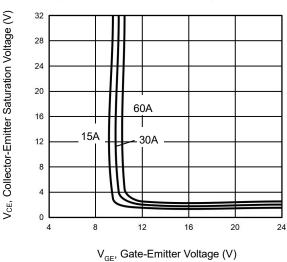
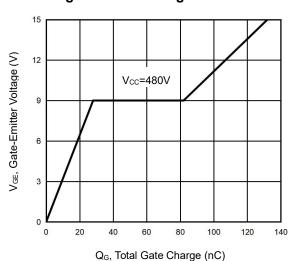


Figure 6 Gate charge waveform



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Typical Electrical and Thermal Characteristics

Figure 7 Gate-emitter Threshold Voltage as a Function of Junction Temperature

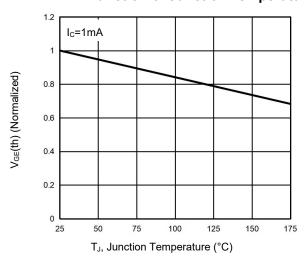


Figure 9 Typical Switching Times as a Function of Gate Resistor

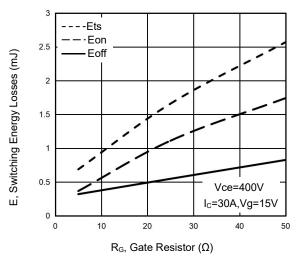


Figure 11 Typical Collector-emitter Saturation Voltage as a function of Collector Current

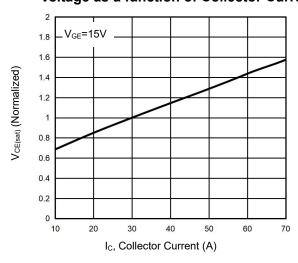


Figure 8 Power Dissipation as a Function of Case Temperature

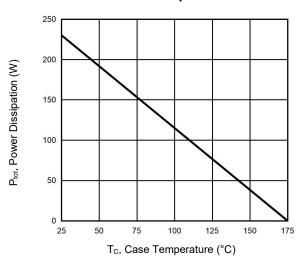


Figure 10 Typical Switching Times as a Function of Junction Temperature

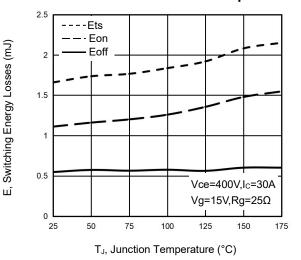
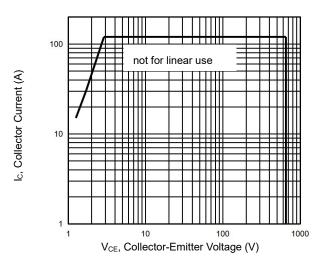


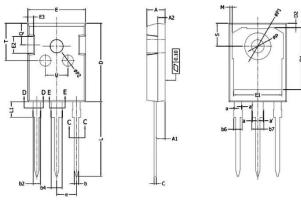
Figure 12 Forward Bias Safe Operating Area



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TO-247-P Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.90	5.10	0.19	0.20	
A1	2.31	2.51	0.09	0.10	
A2	1.90	2.10	0.08	0.09	
а	0.00	0.15	0.00	0.01	
a'	0.00	0.15	0.00	0.01	
b	1.16	1.26	0.05	0.06	
b2	1.96	2.06	0.08	0.09	
b4	2.96	3.06	0.12	0.13	
b6	-	2.25	-	0.09	
b7	-	3.25	-	0.13	
С	0.59	0.66	0.02	0.03	
D	20.90	21.10	0.82	0.83	
D1	16.25	16.85	0.64	0.66	
D2	1.05	1.35	0.04	0.05	
E	15.70	15.90	0.62	0.63	
E1	13.10	13.50	0.52	0.53	
E2	4.40	4.60	0.17	0.18	
E3	2.40	2.60	0.09	0.10	
е	5.43	6 BSC	0.214 E	BSC	
L	19.80	20.10	0.78	0.79	
L1	-	4.30	-	0.17	
М	0.35	0.95	0.01	0.04	
Р	3.40	3.60	0.13	0.14	
P1	7.00	7.40	0.28	0.29	
P2	2.40	2.60	0.09	0.10	
Q	5.60	6.00	0.22	0.24	
S	6.05	6.25	0.24	0.25	
Т	9.80	10.20	0.39	0.40	
U	6.00	6.40	0.24	0.25	





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